

**Implementation status of PMP for Cellular Mobile Handsets and parts thereof**

<b>Year</b>	<b>Sub-Assembly</b>
<b>2016-17</b>	(i) Charger/ Adapter, (ii) Battery Pack, (iii) Wired Headset <b>(Implemented - BCD@15%)</b>
<b>2017-18</b>	(iv) Mechanics, (v) Die Cut Parts, (vi) Microphone and Receiver, (vii) Key Pad, (viii) USB Cable <b>(Implemented - BCD@15%)</b>
<b>2018-19</b>	(ix) Printed Circuit Board Assembly (PCBA), (x) Camera Module, (xi) Connectors <b>(Implemented - BCD@10%)</b>
<b>2019-20</b>	(xii) Display Assembly, (xiii) Touch Panel/ Cover Glass Assembly, (xiv) Vibrator Motor / Ringer

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